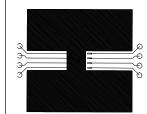


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| Symbol | Parameter | Conditions | Min | Тур | Max | Units |
|----------------------------------|---|--|-----|--------|-------|-------|
| OFF CHAR | ACTERISTICS | | | | | |
| BV _{DSS} | Drain-Source Breakdown Voltage | $V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$ | 30 | | | V |
| $\Delta BV_{DSS} / \Delta T_{J}$ | Breakdown Voltage Temp. Coefficient | $I_{\rm D}$ = 250 µA, Referenced to 25 °C | | 23 | | mV/°C |
| IDSS | Zero Gate Voltage Drain Current | $V_{DS} = 24 V, V_{GS} = 0 V$ | | | 1 | μA |
| | | $T_{J} = 55^{\circ}C$ | | | 10 | μA |
| | Gate - Body Leakage, Forward | V _{GS} = 20 V, V _{DS} = 0 V | | | 100 | nA |
| | Gate - Body Leakage, Reverse | $V_{GS} = -20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$ | | | -100 | nA |
| ON CHARAC | CTERISTICS (Note 2) | | | • | | |
| V _{GS(th)} | Gate Threshold Voltage | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$ | 1 | 1.7 | 3 | V |
| $\Delta V_{GS(th)} / \Delta T_J$ | Gate Threshold Voltage Temp.Coefficient | $I_{\rm D}$ = 250 µA, Referenced to 25 °C | | -5 | | mV/ºC |
| R _{DS(ON)} | Static Drain-Source On-Resistance | $V_{GS} = 10 \text{ V}, I_{D} = 11.5 \text{ A}$ | | 0.0085 | 0.01 | Ω |
| | | T _J =125°C | | 0.014 | 0.017 | |
| | | $V_{GS} = 4.5 \text{ V}, I_{D} = 9.5 \text{ A}$ | | 0.0125 | 0.015 | |
| I _{D(ON)} | On-State Drain Current | $V_{GS} = 10 \text{ V}, V_{DS} = 5 \text{ V}$ | 50 | | | Α |
| 9 _{FS} | Forward Transconductance | $V_{DS} = 15 \text{ V}, \ \text{I}_{D} = 11.5 \text{ A}$ | | 40 | | S |
| DYNAMIC C | HARACTERISTICS | | | | | • |
| C _{iss} | Input Capacitance | $V_{DS} = 15 V, V_{GS} = 0 V,$ f = 1.0 MHz | | 2070 | | pF |
| C _{oss} | Output Capacitance | f = 1.0 MHz | | 510 | | pF |
| C _{rss} | Reverse Transfer Capacitance | | | 235 | | pF |
| SWITCHING | CHARACTERISTICS (Note 2) | | | | | |
| t _{D(on)} | Turn - On Delay Time | $V_{DS} = 15 \text{ V}, \text{ I}_{D} = 1 \text{ A}$ | | 13 | 21 | ns |
| t _r | Turn - On Rise Time | V_{GS} = 10 V , R_{GEN} = 6 Ω | | 10 | 18 | ns |
| t _{D(off)} | Turn - Off Delay Time | | | 36 | 58 | ns |
| t _r | Turn - Off Fall Time | | | 13 | 23 | ns |
| Q _g | Total Gate Charge | $V_{\rm DS} = 15 \text{ V}, \ I_{\rm D} = 11.5 \text{ A},$ | | 19 | 27 | nC |
| Q _{gs} | Gate-Source Charge | $V_{GS} = 5 V$ | | 7 | | nC |
| Q _{gd} | Gate-Drain Charge | | | 6 | | nC |
| DRAIN-SOUI | RCE DIODE CHARACTERISTICS AND MAXI | MUM RATINGS | | | | |
| I _s | Maximum Continuous Drain-Source Diode Forward Current | | | | 2.1 | Α |
| V _{SD} | Drain-Source Diode Forward Voltage $V_{GS} = 0 \text{ V}, I_S = 2.1 \text{ A}_{(Note 2)}$ | | | | 1.2 | V |

Notes:

1. R_{guk} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{guc} is guaranteed by design while R_{gck} is determined by the user's board design.





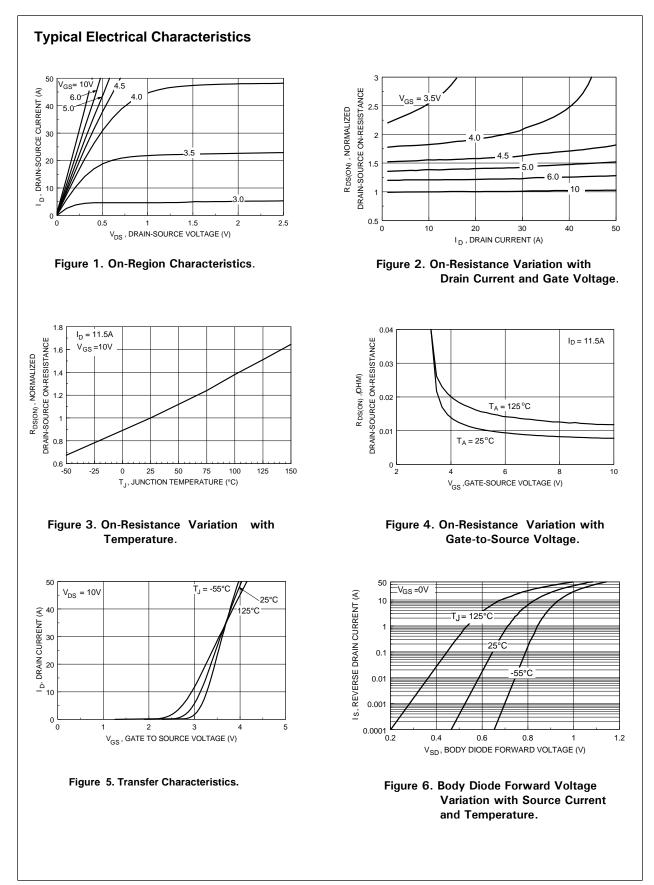


b. 105°C/W on a 0.04 in² pad of 2oz copper.

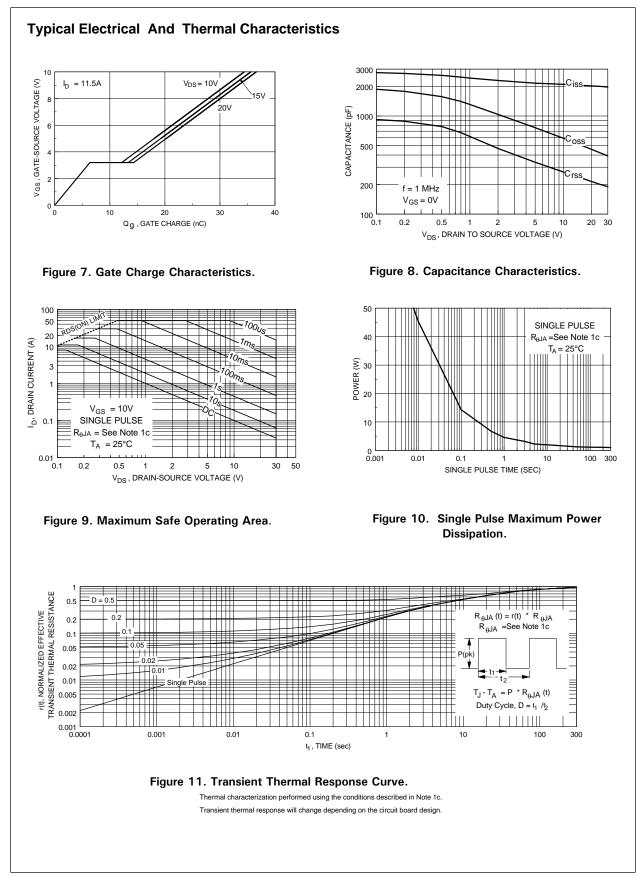


Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2.0%.



FDS6680 Rev.E1



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